

GENERAL DESCRIPTION

This device utilizes the most advanced design and process technologies. These features provide the most consistent and reliable chip and package combination designed, built and tested specifically for use in airborne DME.

- Gold thin-film metallization -- proven highest Mean Time to Failure.
- Surface passivation -- eliminates contamination and extends life.
- Eutectic die attach -- reduces junction temperature and extends MTTF.
- Gold controlled-loop wire bonding -- consistent RF performance.
- Hermetically sealed low thermal-resistance packages -- reduce junction temperature and extend life.

ABSOLUTE MAXIMUM RATINGS

Maximum Power Dissipation @ 25°C Case Temperature 875W

Maximum Voltage and Current

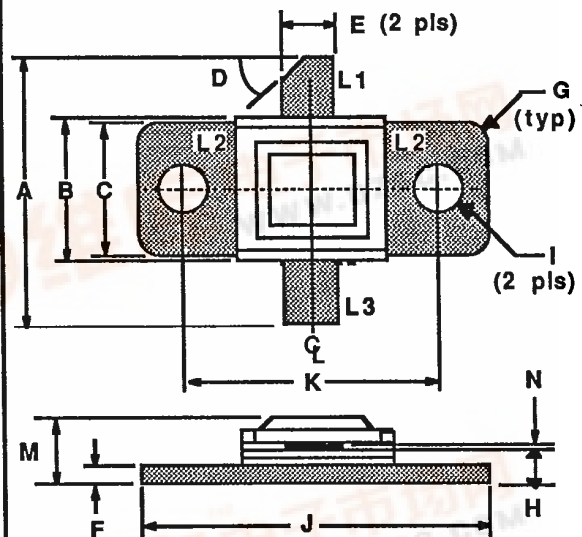
BVces Collector to Emitter Voltage 55 V
BVebo Emitter to Base Voltage 4.0 V
Ic Collector Current 30 A

Maximum Temperatures

Storage Temperature -65 to +200 °C
Operating Junction Temperature +200 °C

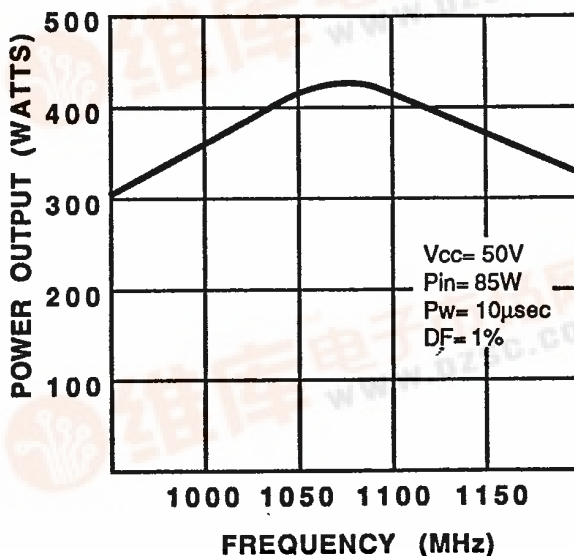
DME 375A
375 WATTS - 50 VOLTS
1025/1150 MHz

AVIONICS



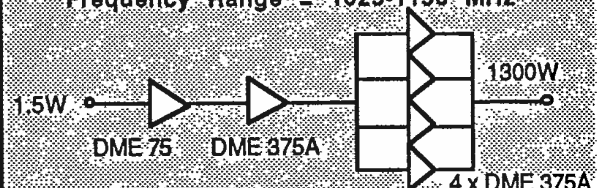
DIM	Millimeter	TOL	Inches	TOL
L1 : c				
L2 : b				
L3 : e				
A	20.32	.76	.800	.030
B	10.16	.13	.400	.005
C	9.78	.13	.385	.005
D	45°	5°	45°	5°
E	3.81	.13	.150	.005
F	1.52	.13	.060	.005
G	1.52 R	.13	.060 R	.005
H	3.05	.13	.120	.005
I	3.30 DIA	.13	.130 DIA	.005
J	22.86	.13	.900	.005
K	16.51	.13	.650	.005
M	5.46	REF	.215	REF
N	0.13	.02	.005	.001

(TYPICAL) POWER OUTPUT



TYPICAL AMPLIFIER LINE UP

Vcc = 50Volts
Frequency Range = 1025-1150 MHz

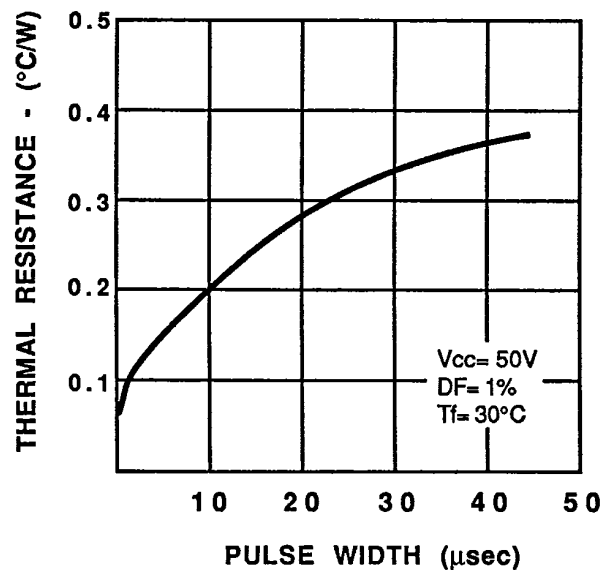


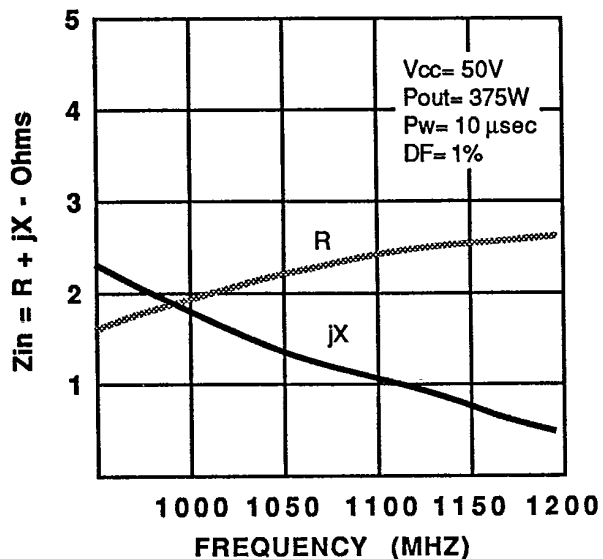
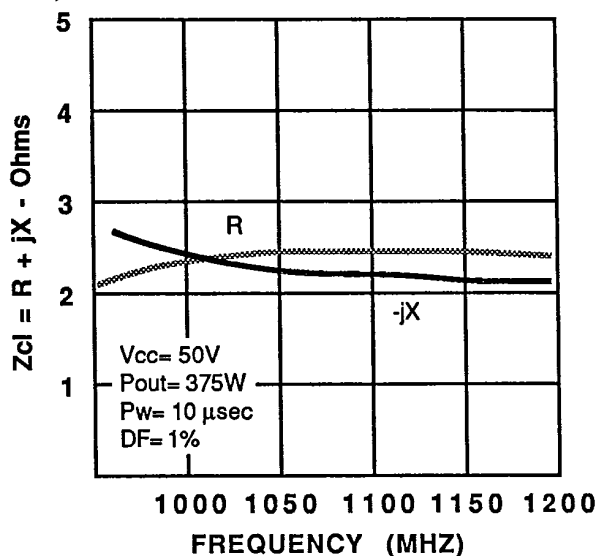
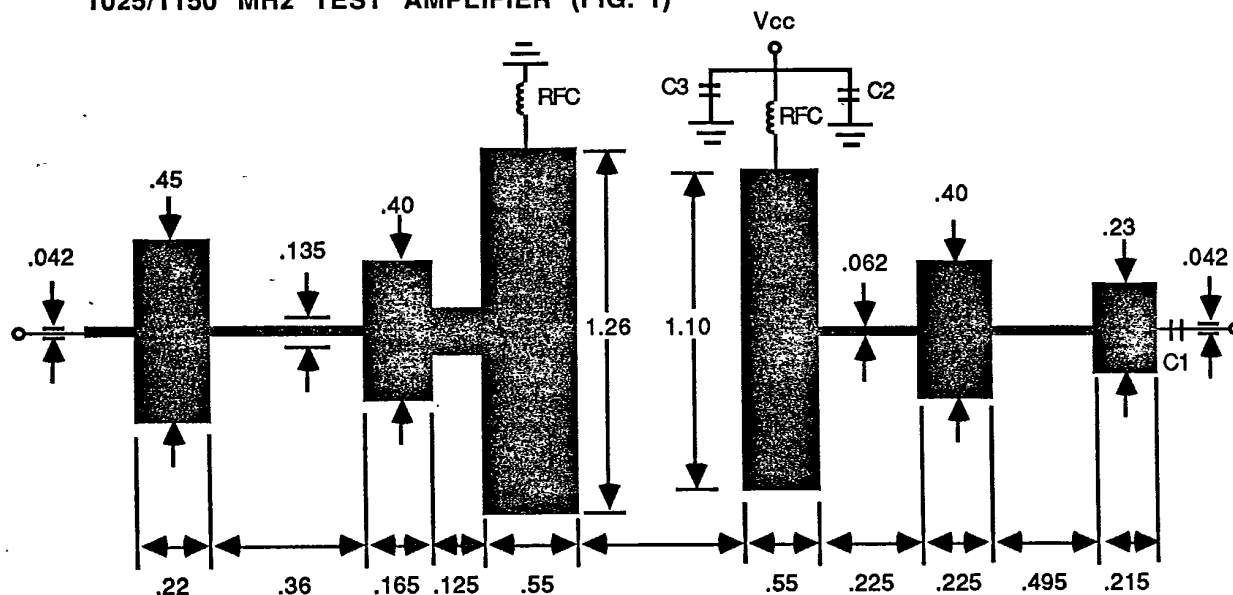
DME 375A-2**ELECTRICAL CHARACTERISTICS¹**

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
P _{out}	Power Output	f = 1025 to 1150 MHz V _{cc} = 50 Volts P _w = 10μsec Df = 1%	375			Watts
P _{in}	Power Input				85	Watts
P _g ²	Power Gain			6.5		dB
η _c ²	Collector Efficiency			40		%
VSWR ²	Load Mismatch Tolerance				∞:1	
BV _{ebo}	Breakdown Voltage (Emitter to Base)	I _c = 0A, I _e = 20mA	4.0			Volts
BV _{ces}	Breakdown Voltage (Collector to Emitter)	V _{be} = 0A, I _c = 25mA	55			Volts
h _{FE}	DC-Current Gain	V _c = 5V, I _c = 300mA	10			
θ _{jc}	Thermal Resistance				0.2	°C/W

Note 1: T_c = +25°C unless otherwise specified

Note 2: At rated power output

**THERMAL RESISTANCE VS
PULSE WIDTH**

DME375A-3**SERIES INPUT IMPEDANCE VS
FREQUENCY (TYPICAL)****SERIES LOAD IMPEDANCE VS
FREQUENCY (TYPICAL)****1025/1150 MHz TEST AMPLIFIER (FIG. 1)**

PCB = .020 TFE, 2 oz., Type "GT"
 C1, 2 = 82pf Chip
 C3 = 250 MFD